

Data Sheet	AMM-3742-T-WP-R

Specifications

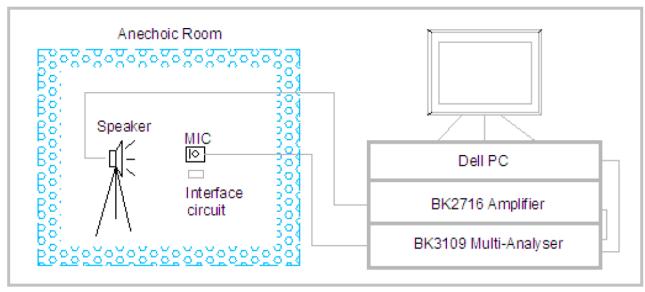
Parameters	Values	Units	
Sensitivity (1 kHz @ 50cm)			
0 dB=1V/Pa	-42±1	dB	
Rated Voltage	1.5	VDC	
Operating Voltage Range	1.5 to 3.6	VDC	
Output Impedance (@ 1 kHz)	300	Ω	
Current consumption (at 1.8 VDC)	200	μА	
Signal-to-Noise Ratio (1kHz, 94 dB input, A-weighted)	59	dB	
Decreasing Voltage (0 dB=1V/Pa, 3.6 to 1.5 VDC)	0.5	dB	
Frequency Range	20 - 20,000	Hz	
Total Harmonic Distortion			
(94 dB @ 50cm, 1 kHz)	0.5%	-	
Acoustic Overload Point (AOP) (50cm, 1kHz, 10% THD)	130	dB	
Directivity	Omnidirectional		
Acceptable Soldering Methods	Reflow Solder	See page 5 for soldering information	
Environmental Compliances	RoHS/	Halogen Free	
Power Supply Rejection (PSR, 100 mVpp Square Wave			
@ 217 Hz, A-weighted)	-100	dB	
Weight	<0.3	Grams	
Operating Temperature (VDD < 3 VDC)	-40 ~ +100	°C	
Operating Temperature (VDD > 3 VDC)	-40 ~ +70	°C	
Storage Temperature	-40 ~ +125	°C	
Environmental Protection Rating	IP57	-	
MSL (Moisture Sensitivity Level) *	1	-	

^{*}MSL level dependent on product remaining in sealed packaging until use

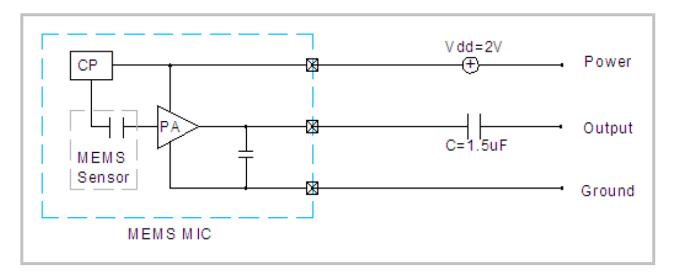
Absolute Maximum Ratings

Parameters	Values	Units	
Max Voltage on Any Pin	4	VDC	
Max Sound Pressure Level	160	dB	
Max Mechanical Shock	10,000	Gs	
Max Vibration	Pre-MIL-STD-883 Method 2007, Test Condition B		

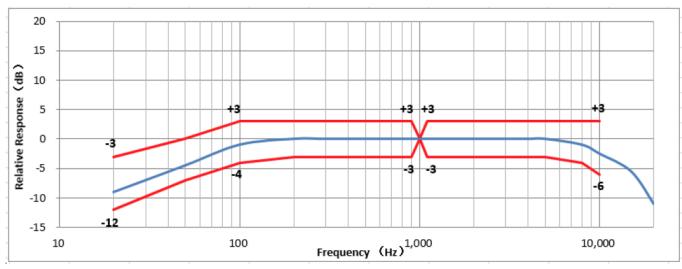
Measurement Method



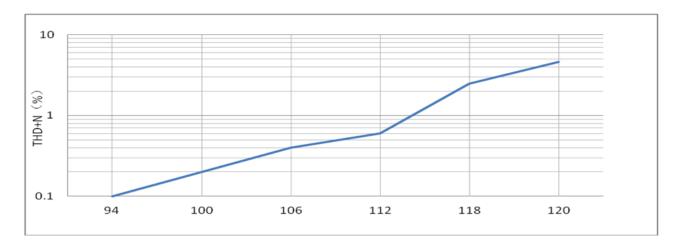
Recommended Drive Circuit



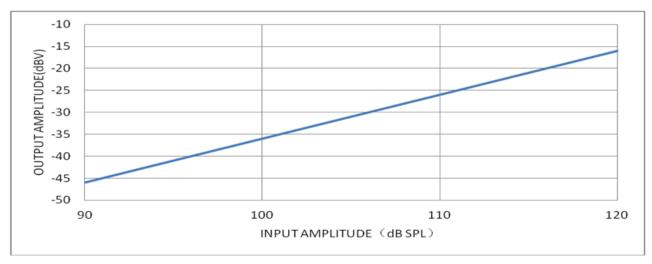
Typical Frequency Response with Pass/Fail Mask



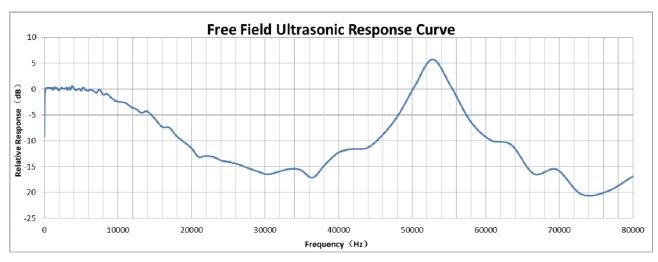
Total Harmonic Distortion + Noise versus SPL Input (with acoustic source at 50cm)



Microphone Output versus SPL Input (with acoustic source at 50cm)

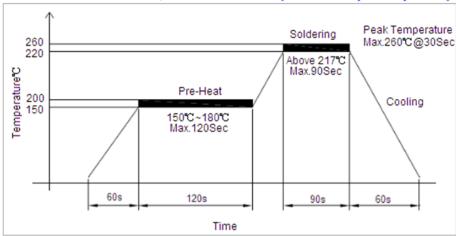


Ultrasonic Frequency Response (Sensitivity normalized to 0 dB)



Recommended Soldering Procedure

Recommend Reflow Profile, solder reflow <=260°C (for 30s Max of peak temperature).



Important Notes

In order to minimize device damage:

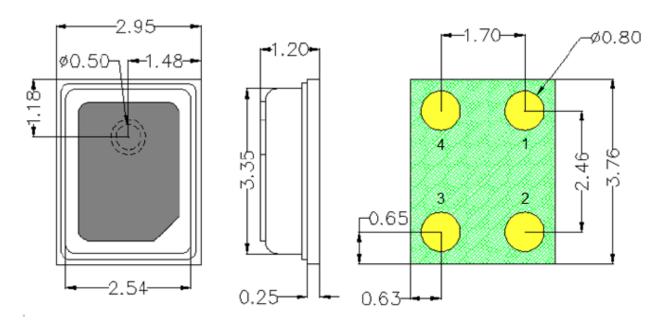
- 1. Do not wash or clean PCBAs after the reflow process.
- 2. Do not apply over 0.3Mpa of air pressure into the microphone sound hole.
- 3. Do not expose microphone to ultrasonic processing or cleaning.
- 4. Do not place a vacuum over the microphone sound hole.

Reliability Testing

Type of Test	Test Specifications
Simulated Reflow (Without Solder)	Samples for qualification testing require 3 passes 260±5 °C reflow solder profiles. 2 hours of setting time is required between each reflow profile test.
Static Humidity	Precondition at +25°C for 1 hour. Expose to +85°C with 85% relative humidity for 1000 hours. Finally, dry at room ambient for 3±1 hour before taking final measurement.
Temperature Shock	Each cycle shall consist of 30 minutes at -40°C, 30 minutes at +125°C with 5 minutes transition time. Test duration is for 30 cycles, starting from cold to hot temperature.
ESD Sensitivity	Perform ESD sensitivity threshold measurements for each contact according to MIL-STD-883G, Method 3015.7 for Human Body Model. Identify the ESD threshold levels indicating passage of 8000V Human Body Model.
Vibration Test	Vibrate randomly along three perpendicular directions for 30 minutes in each direction, 4 cycles from 20~2000 Hz with a peak acceleration of 20 Gs.
Shock Test	Subject samples to half-sine shock pulses (3000±15% Gs for 0.3ms) in each direction, for a total of 18 shocks.
Drop Test	Drop samples from 1.5m height onto a steel surface, total 18 times and inspected for mechanical damage.
Operation Life	Subject samples to +125°C for 168 hours under full maximum rated voltage.
Waterproof Test	Place 15 microphones in water at 1m depth for 30 minutes. Remove and dissect 5 pieces to check for water ingress. Test remaining 10 microphones for sensitivity after resting at room temperature for 2 hours.

Microphone frequency response and sensitivity shall not deviate more than ±3 dB.

Dimensions



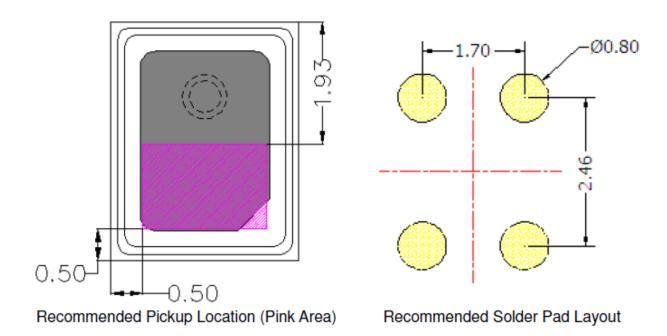
Item	Dimension	Tolerance(+/-)	Units
Length(L)	3.76	0.10	mm
Width(W)	2.95	0.10	mm
Height(H)	1.20	0.10	mm
Acoustic Port(AP)	Ø0.5	0.05	mm

Pin #	Pin Name	Type	Description
1	Output	Signal	Output Signal
2	GND	Ground	Ground
3	GND	Ground	Ground
4	V _{DD}	Power	Power Supply

Notes:

All dimensions are in millimeter (mm). Tolerance±0.15mm unless otherwise specified.

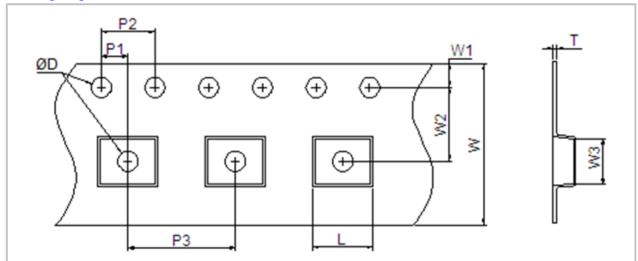
Suggested Pickup Tool Location and Land Pattern*



*This land pattern is advisory only and its use or adaptation is entirely voluntary. PUI Audio disclaims all liability of any kind associated with the use, application, or adaptation of this land pattern.

Packaging

Tape Specification



Cross h a l	Dimension			
Symbol	Minimum	Nominal	Maximum	
ØD	1.5	1.5	1.6	
P1	1.9	2.0	2.1	
P2	3.9	4.0	4.1	
Р3	7.9	8.0	8.1	
L	4.0	4.1	4.2	
W	11.7	12	12.3	
W1	1.65	1.75	1.85	
W2	5.4	5.5	5.6	
W3	3.3	3.4	3.5	
T	0.25	0.3	0.35	

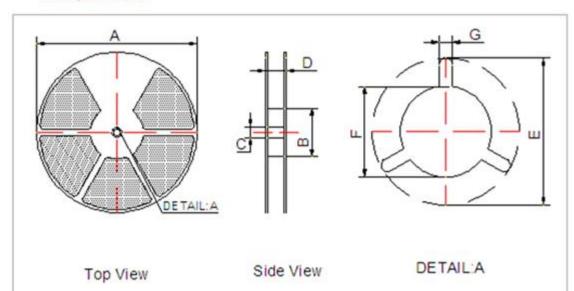
Notes

All dimensions are in millimeter (mm).

 $Tolerance \pm 0.15 mm\ unless\ otherwise\ specified.$

Packaging (continued)

Reel Specification



7" Reel

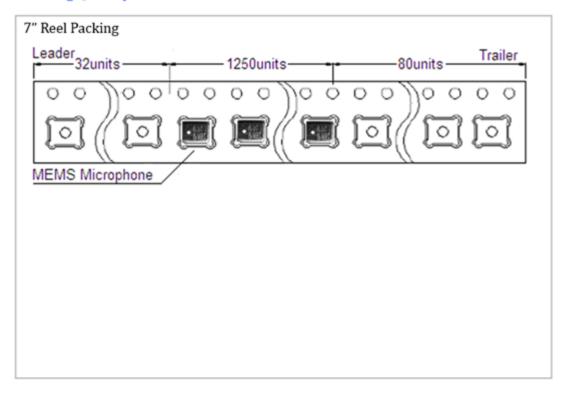
D		Dimension (mm)		
Description	Symbol	Minimum	Nominal	Maximum
Reel Diameter	A	10.75	180	-
Hub Diameter	В	58	60	62
Hub Hole Diameter	С	12.8	13	13.5
Reel Width (Measured at hub)	D	-	16	16.4
Arbor Hole	Е	20.2		
Arbor Hw in mm Diameter	F	12.8	13.0	13.5
Arbor Slot Width	G	1.5		-

Notes

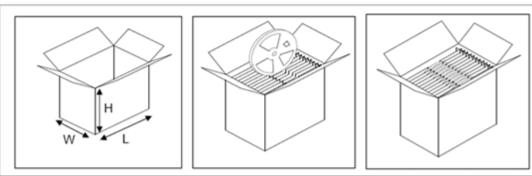
All dimensions are in millimeter (mm).

Packaging (continued)

Packing Quantity



Packing Information



Qty/reel	Weight/reel	Reel/Carton	Qty/carto n	Weight full	Dimension carton Box	Storage
Pcs	Kg	Nos	Nos	Load(kg)	(L x W x H) mm	Temp
1250	0.25	4	5000	~3.00	272 x 159 x 236	-10°C~50°

Specifications Revisions

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Revision	Description	Date	
-	Released from Engineering	10/12/2020	

Note:

- 1. Unless otherwise specified:
 - A. All dimensions are in millimeters.
 - B. Default tolerances are ± 0.5 mm and angles are $\pm 3^{\circ}$.
- 2. Specifications subject to change or withdrawal without notice.